

MOS FIELD EFFECT TRANSISTOR μ**PA2712GR**

SWITCHING P-CHANNEL POWER MOS FET

DESCRIPTION

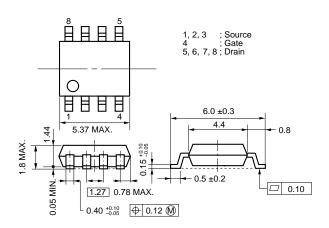
The µPA2712GR is P-Channel MOS Field Effect Transistor designed for power management applications of notebook computers and Li-ion battery protection circuit.

FEATURES

- Low on-state resistance $R_{DS(on)1} = 13 \text{ m}\Omega \text{ MAX.}$ (Vgs = -10 V, ID = -5.0 A) $R_{DS(on)2} = 21 \text{ m}\Omega \text{ MAX.} (V_{GS} = -4.5 \text{ V}, \text{ ID} = -5.0 \text{ A})$ $R_{DS(on)3} = 26 \text{ m}\Omega \text{ MAX.} (V_{GS} = -4.0 \text{ V}, \text{ ID} = -5.0 \text{ A})$
- Low Ciss: Ciss = 2000 pF TYP.
- Small and surface mount package (Power SOP8)

ORDERING INFORMATION

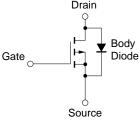
PART NUMBER	PACKAGE
μPA2712GR	Power SOP8



PACKAGE DRAWING (Unit: mm)

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

	, , , , , , , , , , , , , , , , , , ,			,
Drain to Source Voltage (Vgs = 0 V)	Vdss	-30	V	
Gate to Source Voltage (VDs = 0 V)	Vgss	∓20	V	
Drain Current (DC)	D(DC)	∓10	А	EQUIVALENT
Drain Current (pulse) ^{Note1}	D(pulse)	∓40	А	Dra
Total Power Dissipation Note2	P T1	2	W	
Total Power Dissipation Note3	P T2	2	W	, F_
Channel Temperature	Tch	150	°C	Gate
Storage Temperature	Tstg	–55 to +150	°C	+
Single Avalanche Current Note4	las	-10	А	
Single Avalanche Energy Note4	Eas	10	mJ	Sou



- **Notes 1.** PW \leq 10 μ s, Duty Cycle \leq 1%
 - 2. Mounted on ceramic substrate of 1200 mm² x 2.2 mm
 - 3. Mounted on a glass epoxy board (1 inch x 1 inch x 0.8 mm), PW = 10 sec
 - 4. Starting T_{ch} = 25°C, V_{DD} = -15 V, R_G = 25 Ω , L = 100 μ H, V_{GS} = -20 \rightarrow 0 V
- Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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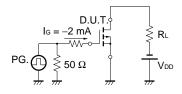
ELECTRICAL CHARACTERISTICS (T_A = 25°C, All terminals are connected.)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-1	μA
Gate Leakage Current	lgss	$V_{GS} = \mp 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			∓100	nA
Gate Cut-off Voltage	V _{GS(off)}	$V_{DS} = -10 \text{ V}, \text{ Id} = -1 \text{ mA}$	-1.0		-2.5	V
Forward Transfer Admittance	y₅	$V_{DS} = -10 \text{ V}, \text{ Id} = -5.0 \text{ A}$	7	15		S
Drain to Source On-state Resistance	RDS(on)1	$V_{GS} = -10 \text{ V}, \text{ Id} = -5.0 \text{ A}$		10	13	mΩ
	RDS(on)2	V _{GS} = -4.5 V, I _D = -5.0 A		15	21	mΩ
	RDS(on)3	$V_{GS} = -4.0 \text{ V}, \text{ ID} = -5.0 \text{ A}$		19	26	mΩ
Input Capacitance	Ciss	V _{DS} = -10 V		2000		pF
Output Capacitance	Coss	V _{GS} = 0 V		550		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		340		pF
Turn-on Delay Time	td(on)	Vdd = -15 V, Id = -5.0 A		10		ns
Rise Time	tr	V _{GS} = -10 V		16		ns
Turn-off Delay Time	td(off)	R _G = 10 Ω		92		ns
Fall Time	tr			51		ns
Total Gate Charge	QG	$V_{DD} = -24 V$		42		nC
Gate to Source Charge	QGS	V _{GS} = -10 V		6		nC
Gate to Drain Charge	Qgd	I _D = 10 A		12		nC
Body Diode Forward Voltage	VF(S-D)	IF = 10 A, VGS = 0 V		0.82		V
Reverse Recovery Time	trr	IF = 10 A, VGS = 0 V		46		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		33		nC

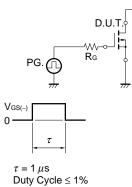
TEST CIRCUIT 1 AVALANCHE CAPABILITY

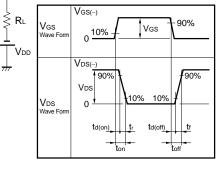
$PG. \bigcirc V_{GS} = -20 \rightarrow 0 V \xrightarrow{H} H \xrightarrow{I_{AS}} V_{DS}$

TEST CIRCUIT 3 GATE CHARGE

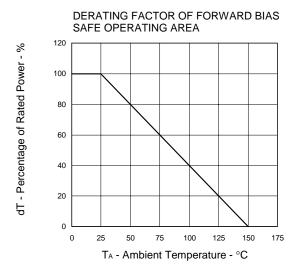


TEST CIRCUIT 2 SWITCHING TIME

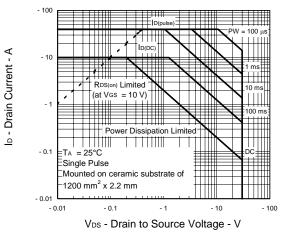


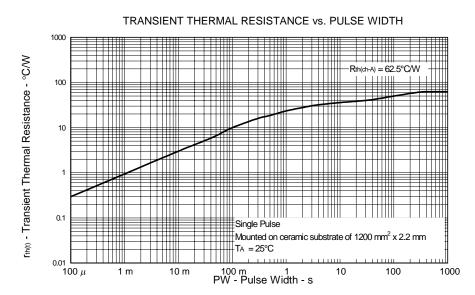


TYPICAL CHARACTERISTICS (TA = 25°C)



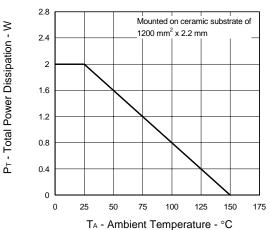
FORWARD BIAS SAFE OPERATING AREA





Data Sheet G15980EJ2V0DS

TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE



*

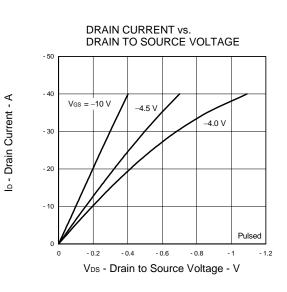
- 3

- 2.5

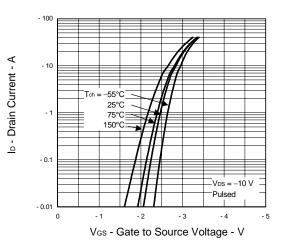
- 1

- 0.5

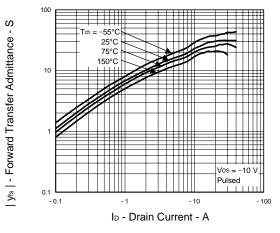
V_{GS(off)} - Gate Cut-off Voltage - V

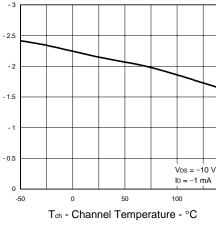


FORWARD TRANSFER CHARACTERISTICS



FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



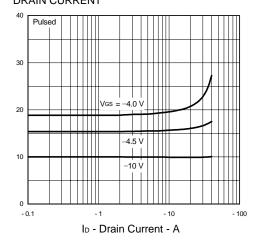


GATE CUT-OFF VOLTAGE vs.

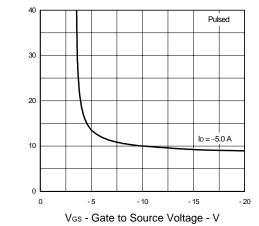
CHANNEL TEMPERATURE

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

150



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



Data Sheet G15980EJ2V0DS

 $R_{DS(cn)}$ - Drain to Source On-state Resistance - $m\Omega$

4

0.2

0

0.4

0.6

0.8

VF(S-D) - Source to Drain Voltage - V

1

1.2

1.4

Ciss

Crss

- 100

- 15

- 10

- 5

- 10

Vgs

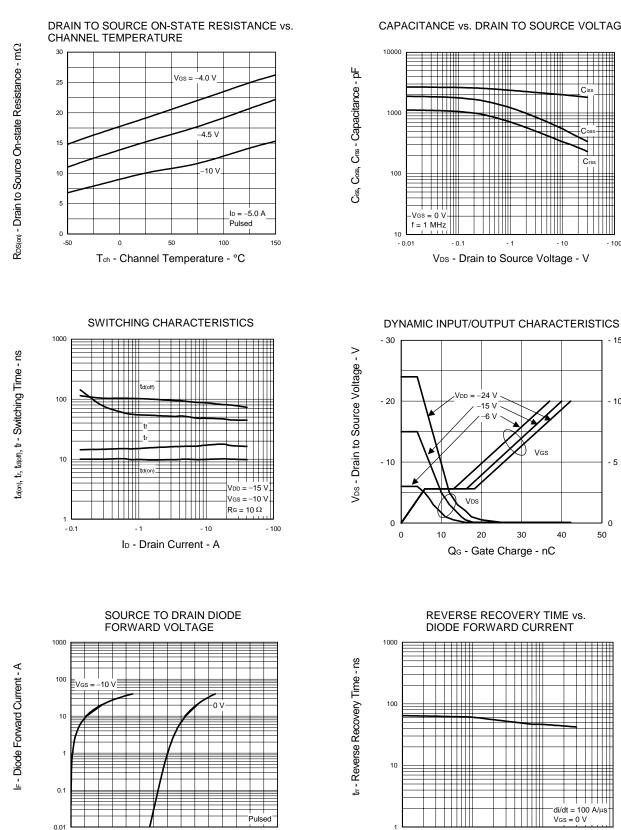
40

30

10

-di/dt = 100 A/μs Vgs = 0 V

100



CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

- 1

Ves - Gate to Source Voltage - V

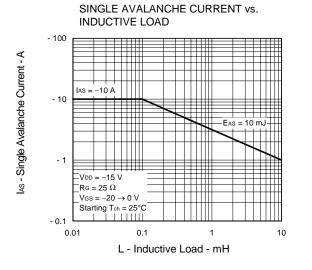
0 50

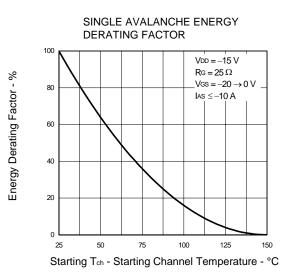
Data Sheet G15980EJ2V0DS

0.1

1

IF - Diode Forward Current - A





[MEMO]

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